TOSHIBA TLSH125

TOSHIBA LED LAMP INGAA P RED LIGHT EMISSION

TLSH125

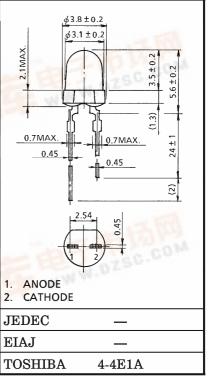
PANEL CIRCUIT INDICATOR

Unit in mm

- 3.1 mm DIAMETER (T1-3/4)
- InGaAℓP RED LED
- Colorless Transparent Lens
- Low Drive Current, High Intensity RED Light Emission
 Recommended Forward Current: IF = 1~20 mA (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- APPLICATIONS: Indicator, Backlight

MAXIMUM RATINGS ($Ta = 25^{\circ}C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current	$I_{\mathbf{F}}$	50	mA
Reverse Voltage	v_{R}	4	V
Power Dissipation	$P_{\mathbf{D}}$	125	mW
Operating Temperature Range	$T_{ m opr}$	-30~85	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~120	°C



Weight: 0.14 g

ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Forward Voltage	$ m V_{ m F}$	$I_{ m F}=20~{ m mA}$	_	2.1	2.5	V
Reverse Current	$I_{\mathbf{R}}$	$V_R = 4 V$	_	_	50	μ A
Luminous Intensity	$I_{ m V}$	$I_F = 20 \text{mA} (\text{Note})$	272	800		mcd
Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	$I_{ m F}=20~{ m mA}$	_	623		nm
Spectral Line Half Width	Δλ	$I_{ m F}=20~{ m mA}$	_	15		nm
Dominant Wavelength	λd	$ m I_F=20~mA$	_	613	_	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity.

Measurement tolerance for each limit is ±15%.

Q: $320\sim640 \text{ mcd}$, R: $560\sim1120 \text{ mcd}$, S: $1000\sim2000 \text{ mcd}$

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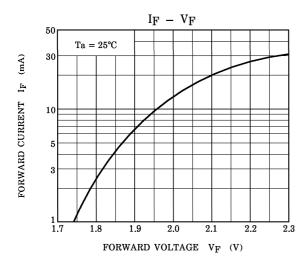
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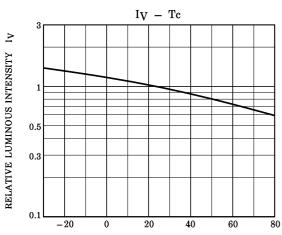
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PRECAUTION

Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.







CASE TEMPERATURE Tc (°C)

 $Ta = 25^{\circ}C$

